



**DNP**  
FID1

**DNP**  
FID2

**DNP**  
FID3

PCB Number: PMP20566  
PCB Rev: A


Variant/Label Table	
Variant	Label Text
001	ChangeMe!
002	ChangeMe!

ZZ1  
**Label Assembly Note**  
This Assembly Note is for PCB labels only

ZZ2  
**Assembly Note**  
These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ3  
**Assembly Note**  
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ4  
**Assembly Note**  
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

Orderable: <a href="#">ChangeMe!</a>	Designed for: <a href="#">Public Release</a>	Mod. Date: 3/3/2017	 TEXAS INSTRUMENTS <a href="http://www.ti.com">http://www.ti.com</a> © Texas Instruments 2016
TID #: N/A	Project Title:		
Number: <a href="#">PMP20566</a>	Rev: <a href="#">A</a>	Sheet Title:	
SVN Rev: Version control disabled	Assembly Variant: <a href="#">001</a>	Sheet: <a href="#">3</a> of <a href="#">3</a>	
Drawn By:	File: <a href="#">EVM_Hardware.SchDoc</a>	Size: B	
Engineer: <a href="#">Nick Saulnier</a>	Contact: <a href="#">N/A</a>		

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